

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









P-Channel Power MOSFET

-30V, -64A, 8.5mΩ

FEATURES

- Low R_{DS(ON)} to minimize conductive losses
- Low gate charge for fast power switching
- 100% UIS and R_q tested
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

ΔD	DI	١Т	1 C

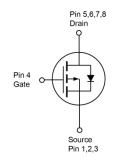
- DC-DC Converters
- Battery Power Management
- Load Switch
- BLDC Motor Drives

KEY PERFORMANCE PARAMETERS			
PARAMETER		VALUE	UNIT
V _D	S	-30	V
R _{DS(on)} (max)	V _{GS} = -10V	8.5	
	V _{GS} = -4.5V	14	mΩ
Q_g		27	nC









Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

PARAMETER Drain-Source Voltage		SYMBOL	LIMIT	UNIT
		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current (Note 1)	$T_C = 25^{\circ}C$		-64	
Continuous Drain Current	$T_A = 25^{\circ}C$	I _D	-14	_ A
Pulsed Drain Current		I _{DM}	-256	Α
Single Pulse Avalanche Current (Note 2)		I _{AS}	-23	Α
Single Pulse Avalanche Energy (Note 2)		E _{AS}	79	mJ
Tatal Davis Dissipation	$T_C = 25^{\circ}C$	Б	50	10/
Total Power Dissipation	T _C = 125°C	P _D	10	W
Tatal Davier Dissination	T _A = 25°C	В	2.4	١٨,
Total Power Dissipation	T _A = 125°C	P _D	0.5	W
Operating Junction and Storage Temperature Range		T _J , T _{STG}	- 55 to +150	°C

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction to Case Thermal Resistance	R _{eJC}	2.5	°C/W	
Junction to Ambient Thermal Resistance	$R_{\Theta JA}$	53	°C/W	

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design.

1



PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static						•
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	BV _{DSS}	-30			V
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	$V_{GS(TH)}$	-1.2	-1.6	-2.5	V
Gate-Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	I _{GSS}			±100	nA
	$V_{GS} = 0V, V_{DS} = -30V$				-1	
Drain-Source Leakage Current	$V_{GS} = 0V, V_{DS} = -30V$ $T_{J} = 125^{\circ}C$	I _{DSS}	100	μΑ		
Drain-Source On-State Resistance	$V_{GS} = -10V, I_D = -14A$	Б		7.1	8.5	— m∩
(Note 3)	$V_{GS} = -4.5V, I_D = -14A$	$R_{DS(on)}$		11	14	
Forward Transconductance (Note 3)	$V_{DS} = -5V, I_{D} = -14A$	g _{fs}		38		S
Dynamic (Note 4)						
Total Gate Charge	$V_{GS} = -10V$, $V_{DS} = -15V$, $I_{D} = -14A$	Q_g		55		
Total Gate Charge	V _{GS} = -4.5V,	Q_g		27		nC
Gate-Source Charge		Q _{gs}		9.2		
Gate-Drain Charge	$V_{DS} = -15V, I_{D} = -14A$	Q_{gd}		9.9		
Input Capacitance		C _{iss}		3234		
Output Capacitance	$V_{GS} = 0V, V_{DS} = -15V$	C _{oss}		396		pF
Reverse Transfer Capacitance	f = 1.0MHz	C _{rss}		251		
Gate Resistance	f = 1.0MHz, open drain	R_g	1.6	6	12	Ω
Switching (Note 4)						
Turn-On Delay Time		t _{d(on)}		7.2		
Turn-On Rise Time	$V_{GS} = -10V, V_{DS} = -15V,$ $I_{D} = -14A, R_{G} = 2\Omega,$	t _r		2.6		
Turn-Off Delay Time		t _{d(off)}		56		ns
Turn-Off Fall Time		t _f		27		
Source-Drain Diode						
Forward Voltage (Note 3)	$V_{GS} = 0V, I_{S} = -14A$	V_{SD}			-1	V
Reverse Recovery Time	I _S = -14A ,	t _{rr}		23		ns
Reverse Recovery Charge	dl/dt = 100A/µs	Q _{rr}		11		nC

Notes:

- 1. Silicon limited current only.
- 2. L = 0.3 mH, $V_{GS} = -10 V$, $V_{DD} = -25 V$, $R_G = 25 \Omega$, $I_{AS} = -23 A$, Starting $T_J = 25 ^{\circ} C$
- 3. Pulse test: Pulse Width \leq 300 μ s, duty cycle \leq 2%.
- 4. Switching time is essentially independent of operating temperature.

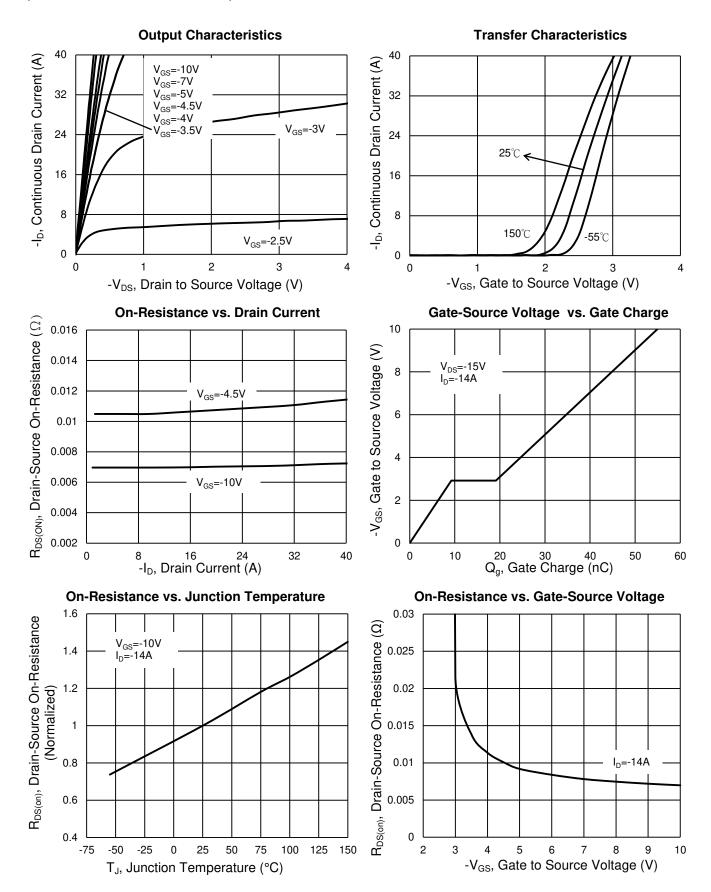
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM085P03CV RGG	PDFN33	5,000pcs / 13" Reel



CHARACTERISTICS CURVES

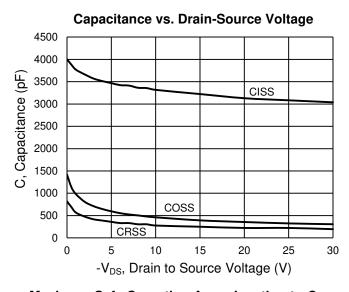
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

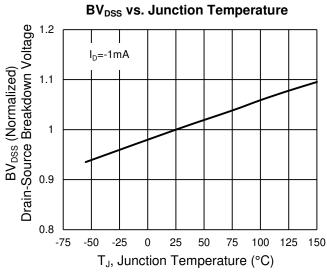




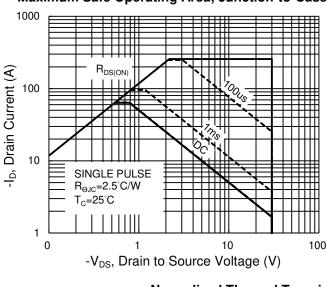
CHARACTERISTICS CURVES

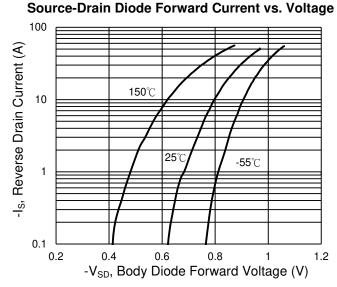
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

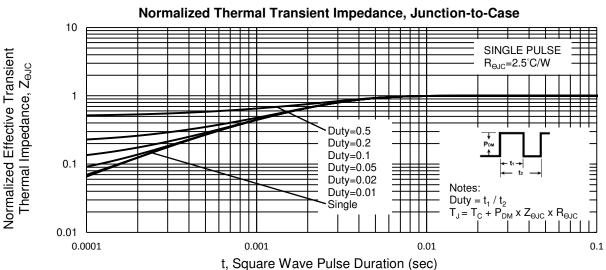




Maximum Safe Operating Area, Junction-to-Case 1000





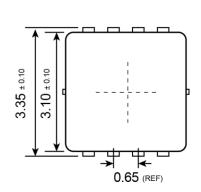


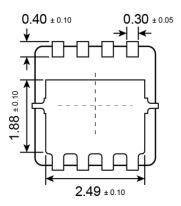


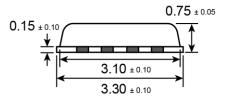


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

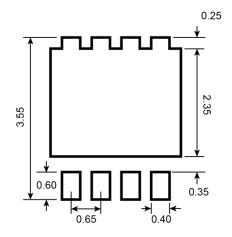
PDFN33







SUGGESTED PAD LAYOUT (Unit: Millimeters)



Y =Nov Z =Dec

5

MARKING DIAGRAM



Y = Year Code

M = Month Code for Halogen Free Product

O =Jan P =Feb Q =Mar R =Apr

 $S = May \quad T = Jun \quad U = Jul \quad V = Aug$

L = Lot Code $(1\sim9, A\sim Z)$

W =Sep X =Oct



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.